AUTOMOTIVE

RoHS

COMPLIANT HALOGEN

FREE



Vishay General Semiconductor

Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



Cathode O Anode

DESIGN SUPPORT TOOLS AVAILABLE



PRIMARY CHARACTERISTICS			
I _{F(AV)}	5.0 A		
V _{RRM}	200 V		
I _{FSM}	90 A		
V _F at I _F = 5.0 A (125 °C)	0.69 V		
T _J max.	175 °C		
Package	SlimSMA (DO-221AC)		
Circuit configuration	Single		

FEATURES

- Very low profile typical height of 0.95 mm
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	VSSAF522	UNIT	
Device marking code		V522		
Maximum repetitive peak reverse voltage	V_{RRM}	200	V	
Maximum average forward rectified current	I _{F(AV)} (1)	2	A	
	I _{F(AV)} (2)	5.0		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	90	А	
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C	
Storage temperature range	T _{STG}	-55 to +175	°C	

Notes

- (1) Free air, mounted on recommended copper pad area
- (2) Mounted on 30 mm x 30 mm pad areas aluminum PCB
- $^{(3)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 2.5 A	T _A = 25 °C	V _E ⁽¹⁾	0.76	-	V	
	I _F = 5.0 A			0.82	0.90		
	I _F = 2.5 A	- T _A = 125 °C	- '	VF \''	0.61	-	V
	I _F = 5.0 A			0.69	0.77		
Reverse current	V _R = 160 V	$V_R = 160 \text{ V}$ $T_A = 25 \text{ °C}$ $T_A = 125 \text{ °C}$	I _R ⁽²⁾	0.001	-		
	v _R = 100 v	T _A = 125 °C		0.3	-	mA	
	V _R = 200 V	T _A = 25 °C T _A = 125 °C		-	0.05	IIIA	
	V _R = 200 V	T _A = 125 °C		0.7	3]	
Typical junction capacitance	4.0 V, 1 MF	4.0 V, 1 MHz		240	-	pF	

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)			
PARAMETER	SYMBOL	VSSAF522	UNIT
Typical thermal resistance	R _{θJA} (1)(2)	115	°C/W
	R _{0JM} (3)	12	C/VV

Notes

 $^{(1)}$ The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

 $^{(2)}$ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction-to-ambient

 $^{(3)}$ Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance $R_{\theta JM}$ - junction-to-mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
VSSAF522-M3/H	0.032	Н	3500	7" diameter plastic tape and reel	
VSSAF522-M3/I	0.032	1	14 000	13" diameter plastic tape and reel	
VSSAF522HM3/H (1)	0.032	Н	3500	7" diameter plastic tape and reel	
VSSAF522HM3/I (1)	0.032	1	14 000	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

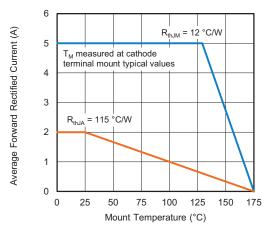


Fig. 1 - Maximum Forward Current Derating Curve

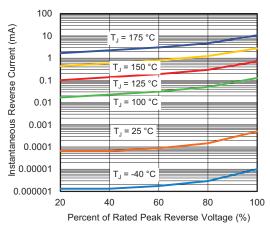


Fig. 4 - Typical Reverse Leakage Characteristics

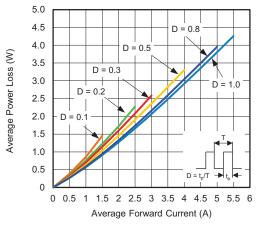


Fig. 2 - Forward Power Loss Characteristics

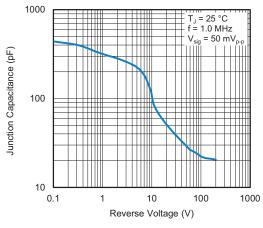


Fig. 5 - Typical Junction Capacitance

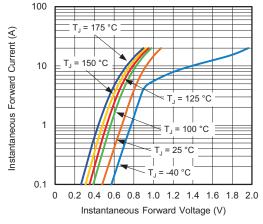


Fig. 3 - Typical Instantaneous Forward Characteristics

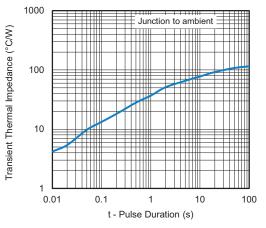


Fig. 6 - Typical Transient Thermal Impedance

0.047 (1.20) MIN.

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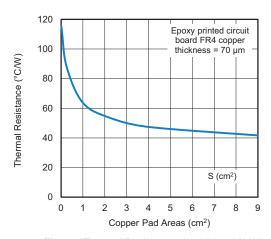


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Area

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimSMA (DO-221AC) Cathode Band 0.057 (1.45) 0.106 (2.70) 0.049 (1.25) 0.098 (2.50) 0.171 (4.35) 0.047 (1.20) Typ.: 0.019 (0.48) 0.163 (4.15) 0.030 (0.75) 0.211 (5.35) 0.199 (5.05) **Mounting Pad Layout** 0.039 (1.00) 0.035, (0.90) 0.060 (1.52) 0.012 (0.30) MIN. 0.006 (0.15)

0.047 (1.20)

MIN.

0.123 (3.12) MAX.

0.217 (5.52) REF.

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